







**CD4016B** SCHS026D - NOVEMBER 1998 - REVISED MAY 2024

# **CD4016B Types CMOS Quad Bilateral Switch**

#### 1 Features

- 20V digital or ± 10V peak-to-peak switching
- 280Ω typical on-state resistance for 15V operation
- Switch on-state resistance matched to within  $10\Omega$ typ over 15V signal-input range
- High on/off output-voltage ratio: 65dB typ at  $f_{is} = 10kHz$ ,  $R_L = 10k\Omega$
- High degree of linearity: <0.5% distortion typ at f  $_{is}$ = 1kHz, V  $_{is}$ = 5V $_{p-p}$ , V  $_{DD}$  -V  $_{SS}$   $\square$  10V, R  $_{L}$  =  $10k\Omega$
- Extremely low off-state switch leakage resulting in very low offset current and high effective offstate resistance: 100pA typ. at V <sub>DD</sub> -V <sub>SS</sub> =18V,  $T_A=25^{\circ}C$
- Extremely high control input impedance (control circuit isolated from signal circuit: 10  $^{12}\,\Omega$  typ.
- Low crosstalk between switches: -50dB typ at f is = 0.9MHz,  $R_{\perp} = 1k\Omega$
- Matched control-input to signal-output capacitance: Reduces output signal transients
- Frequency response, switch on = 40MHz (typical)
- 100% tested for guiescent current at 20V
- Maximum control input current of 1µA at 18V over full package temperature range; 100nA at 18V at 25°C
- 5V, 10V, and 15V parametric ratings

### 2 Applications

- Analog signal switching/multiplexing signal gating
- Modulator squelch control
- Demodulator chopper
- Commutating switch
- Digital signal switching/multiplexing
- CMOS logic implementation
- Analog-to-digital and digital-to-analog conversion
- Digital control of frequency, impedance, phase, and analog-signal gain

## 3 Description

For transmission or multiplexing of analog or digital signals high-voltage types (20V rating).

CD4016B B Series types are quad bilateral switches intended for the transmission or multiplexing of analog or digital signals. Each of the four independent bilateral switches has a single control signal input which simultaneously biases both the p and n device in a given switch on or off.

The CD4016B B Series types are supplied in 14lead hermetic dual-in-line ceramic packages (F3A suffix), 14-lead dual-in-line plastic packages (E suffix), 14-lead small-outline packages (M, MT, M96, and NSR suffixes), and 14-lead thin shrink small-outline packages (PW and PWR suffixes).

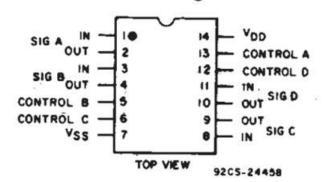
#### **Package Information**

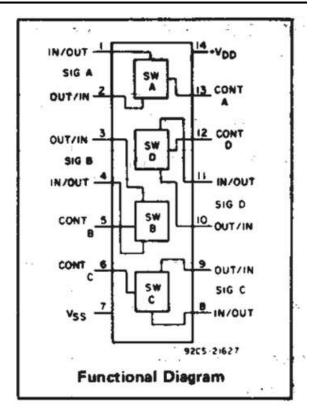
PART NUMBER	PACKAGE <sup>(1)</sup>	PACKAGE SIZE <sup>(2)</sup>
CD4016B	N (PDIP, 14)	19.3mm × 9.4mm
	D (SOIC, 14)	8.65mm × 6mm

- For more information, see Section 8.
- The package size (length × width) is a nominal value and includes pins, where applicable.



# Terminal Assignment





Schematic Diagram - 1 of 4 Identical Sections



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## 4 Specifications

## 4.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1) (2)

		MIN	MAX	UNIT
$V_{DD} - V_{SS}$			20	V
$V_{DD}$	Supply voltage	-0.5	20	V
V <sub>SS</sub>		-20	0.5	V
I <sub>SEL</sub> or I <sub>EN</sub>	Logic control input pin current (EN, Ax, SELx)	-30	30	mA
V <sub>S</sub> or V <sub>D</sub>	Source or drain voltage (Sx, D)	V <sub>SS</sub> -0.5	V <sub>DD</sub> +0.5	V
I <sub>S</sub> or I <sub>D (CONT)</sub>	Source or drain continuous current (Sx, D)	-20	20	mA
TJ	Junction temperature		150	°C
T <sub>stg</sub>	Storage temperature	-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Condition. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## 4.2 ESD Ratings

			VALUE	UNIT
\ <u>\</u>	Floatractatic discharge	Human body model (HBM), per ANSI/ESDA/ JEDEC JS-001, all pins <sup>(1)</sup>	±500	V
V <sub>(ESD)</sub>	Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>	±1500	V

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

### 4.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM MAX	UNIT
V <sub>DD</sub> – V <sub>SS</sub> (1)	Power supply voltage differential	3	18	V
$V_{DD}$	Positive power supply voltage	3	18	V
V <sub>S</sub> or V <sub>D</sub>	Signal path input/output voltage (source or drain pin) (Sx, D)	V <sub>SS</sub>	$V_{DD}$	V
V <sub>SEL</sub> or V <sub>EN</sub>	Address or enable pin voltage	0	$V_{DD}$	V
I <sub>S</sub> or I <sub>D (CONT)</sub>	Source or drain continuous current (Sx, D)	-10	10	mA
T <sub>A</sub>	Ambient temperature	<b>–</b> 55	125	°C

(1)  $V_{DD}$  and  $V_{SS}$  can be any value as long as  $3V \le (V_{DD} - V_{SS}) \le 24V$ , and the minimum  $V_{DD}$  is met.

<sup>(2)</sup> All voltages are with respect to ground, unless otherwise specified.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 4.4 Thermal Information

		CD	CD4016				
	THERMAL METRIC <sup>(1)</sup>	N (PDIP)	D (SOIC)	UNIT			
		14 PINS	14 PINS				
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	93.7	109.7	°C/W			
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	72.5	69.4	°C/W			
$R_{\theta JB}$	Junction-to-board thermal resistance	68.0	67.9	°C/W			
$\Psi_{JT}$	Junction-to-top characterization parameter	50.3	25.8	°C/W			
$\Psi_{JB}$	Junction-to-board characterization parameter	67.3	67.1	°C/W			

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

# 4.5 Electrical Characteristics

Over operating free-air temperature range,  $V_{SUPPLY} = \pm 5V$ , and  $R_1 = 100\Omega$ , (unless otherwise noted)<sup>(1)</sup>

	PARAMETER		TEST CONDITIONS	MIN TYP MAX	UNIT
SIGNAL	. INPUTS (V <sub>IS</sub> ) AND OUTPUTS (V	'os)			•
			T <sub>A</sub> = -55°C	5	
			T <sub>A</sub> = -40°C	5	
		$V_{is} = 0 \text{ to } 5V$ $V_{DD} = 5V$	T <sub>A</sub> = 25°C	4.5 6	1
		TOD ST	T <sub>A</sub> = 85°C	7.5	1
			T <sub>A</sub> = 125°C	7.5	1
			T <sub>A</sub> = -55°C	6	1
			T <sub>A</sub> = -40°C	6	1
		$V_{is} = 0 \text{ to } 10V$ $V_{DD} = 10V$	T <sub>A</sub> = 25°C	5 7	]
			T <sub>A</sub> = 85°C	15	1
	Quiescent Device Current		T <sub>A</sub> = 125°C	15	
DD			T <sub>A</sub> = -55°C	7	μA
			T <sub>A</sub> = -40°C	7.2	
		$V_{is} = 0 \text{ to } 15V$ $V_{DD} = 15V$	T <sub>A</sub> = 25°C	6 8	]
		TOD 101	T <sub>A</sub> = 85°C	30	1
			T <sub>A</sub> = 125°C	30	
			T <sub>A</sub> = -55°C	8.5	
			T <sub>A</sub> = -40°C	8.5	
	$V_{is} = 0 \text{ to } 20V$ $V_{DD} = 20V$	T <sub>A</sub> = 25°C	6.5 9		
		100 201	T <sub>A</sub> = 85°C	150	]
			T <sub>A</sub> = 125°C	150	]

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## 4.5 Electrical Characteristics (continued)

Over operating free-air temperature range,  $V_{SUPPLY} = \pm 5V$ , and  $R_L = 100\Omega$ , (unless otherwise noted)<sup>(1)</sup>

	erating free-air temperature rang PARAMETER			ONDITIONS		MIN TYP	MAX	UNIT
				T <sub>A</sub> = -55°C			600	
			V <sub>DD</sub> = 10V	T <sub>A</sub> = -40°C			610	
			$V_{is} = V_{SS}$ or	T <sub>A</sub> = 25°C		250	660	
			$V_{DD}$	T <sub>A</sub> = 85°C			840	
				T <sub>A</sub> = 125°C			960	
				T <sub>A</sub> = -55°C			1870	
			V <sub>DD</sub> = 10V	T <sub>A</sub> = -40°C			1900	
			$V_{is} = 4.75 \text{ to}$	T <sub>A</sub> = 25°C			2000	
		to	5.75V	T <sub>A</sub> = 85°C			2380	
	ON Resistance r <sub>ON</sub> Max	to (V <sub>DD</sub> +V <sub>SS</sub> )/2,		T <sub>A</sub> = 125°C			2600	
r <sub>ON</sub>		$V_C = V_{DD}$		T <sub>A</sub> = -55°C			360	Ω
		$RL = 10k\Omega$	V <sub>DD</sub> = 15V	T <sub>A</sub> = -40°C			370	
			$V_{is} = V_{SS}$ or	T <sub>A</sub> = 25°C		200	400	
			$V_{DD}$	T <sub>A</sub> = 85°C			520	
				T <sub>A</sub> = 125°C			600	
			V <sub>DD</sub> = 15V	T <sub>A</sub> = -55°C			775	
				T <sub>A</sub> = -40°C			790	
			$V_{is} = 7.25 \text{ to}$	T <sub>A</sub> = 25°C			850	
			7.75V	T <sub>A</sub> = 85°C			1080	
				T <sub>A</sub> = 125°C			1230	
			$V_{DD} = 5V$ $V_{SS} = 0V$	T <sub>A</sub> = 25°C		580	7000	
r	ON Posistance r May	N Resistance $r_{ON}$ Max $ \begin{cases} to \\ (V_{DD} + V_{SS})/2 \\ V_C = V_{DD}, \\ RL = 10k\Omega \end{cases} $	$V_{DD} = 7.5V$ $V_{SS} = -7.5V$	T <sub>A</sub> = 25°C		200	280	Ω
r <sub>ON</sub>	ON Resistance ION Max		$V_{DD} = 5V$ $V_{SS} = -5V$	T <sub>A</sub> = 25°C		250	580	1 22
			$V_{DD} = 2.5V$ $V_{SS} = -2.5V$	T <sub>A</sub> = 25°C		520	30000	
			V <sub>DD</sub> = 5V			15	5	
∆R <sub>ON</sub>	On-state resistance difference between any two switches	$R_L = 10k\Omega$ , $V_C = V_{DD}$	V <sub>DD</sub> = 10V			10	)	Ω
	Setween any two emicence	, C , DD	V <sub>DD</sub> = 15V				5	
THD	Total Harmonic Distortion	V <sub>C</sub> = V <sub>DD</sub> = 5\ on 0V), R <sub>L</sub> = 1	$V_{SS} = -5V, V_{is}$ $V_{SS} = -5V, V_{is}$ $V_{SS} = -5V, V_{is}$	sine wave	ave centered	0.4	ļ	%
BW	-3-dB cutoff frequency (switch on)	V <sub>C</sub> = V <sub>DD</sub> = 5\ on 0V), R <sub>L</sub> = 1		s(p-p) = 5V (sine wa	ave centered	4(	)	MHz
OISO	-50-dB feedthrough frequency (switch off)	V <sub>C</sub> = V <sub>DD</sub> = 5\ on 0V), R <sub>L</sub> = 1		s(p-p) = 5V (sine wa	ave centered	1.25	5	MHz
				T <sub>A</sub> = -55°C		-0.1	0.1	
	Input/Output Leakage Current V <sub>C</sub>	V <sub>DD</sub> = 18V		T <sub>A</sub> = -40°C		-0.1	0.1	
is		$V_C = 0V$ $V_{is} = 18V, V_{os}$				0.000		μA
		$V_{is} = 0V, V_{os} =$		T <sub>A</sub> = 85°C		-1	1	
				T <sub>A</sub> = 125°C		-1	1	
XTALK	-50-dB crosstalk frequency	V <sub>C</sub> = V <sub>DD</sub> = 5\ on 0V), R <sub>L</sub> = 1		s(p-p) = 5V (sine wa	ave centered	0.9	)	MHz



# **4.5 Electrical Characteristics (continued)**

Over operating free-air temperature range,  $V_{SUPPLY} = \pm 5V$ , and  $R_L = 100\Omega$ , (unless otherwise noted)<sup>(1)</sup>

	PARAMETER		TEST CONDITIONS			TYP	MAX	UNIT
		$V_C = V_{DD}, V_{SS}$	V <sub>DD</sub> = 5V			40	100	
		= GND V <sub>IS</sub> = Square	V <sub>DD</sub> = 10V			20	40	
t <sub>pd</sub>	Propagation delay	Wave 0 to $V_{DD}$ , $C_L = 50$ pF, $R_L = 200$ k $\Omega$	V <sub>DD</sub> = 15V			15	30	ns
C <sub>IS</sub>	Input capacitance	V <sub>DD</sub> = 5V, VC =	= V <sub>SS</sub> = -5V			4		pF
Cos	Output capacitance	V <sub>DD</sub> = 5V, VC =	= V <sub>SS</sub> = -5V			4		pF
C <sub>IOS</sub>	Feed through	V <sub>DD</sub> = 5V, VC =	= V <sub>SS</sub> = -5V			0.2		pF
				T <sub>A</sub> = -55°C			0.9	
	Control input, low voltage (max)	$ \begin{vmatrix}  I_{is}  < 10\mu A, \\ V_{is} = V_{SS}, V_{OS} \end{vmatrix} $	V = 5V	T <sub>A</sub> = -40°C			0.9	
$V_{ILC}$		$= V_{DD}$ , and $V_{is}$	$V_{DD} = 10V$	T <sub>A</sub> = 25°C			0.7	V
			V <sub>DD</sub> = 15V	T <sub>A</sub> = 85°C			0.4	
		V <sub>SS</sub>		T <sub>A</sub> = 125°C			0.4	
			V <sub>DD</sub> = 5V		3.5			V
$V_{IHC}$	Control input, high voltage	See Figure 10	V <sub>DD</sub> = 10V		7			V
			V <sub>DD</sub> = 15V		11			V
I <sub>IH</sub>	Input High Lekaage		V <sub>DD</sub> = 18V			0.5	1	μA
I <sub>IL</sub>	Input Low Leakage		V <sub>DD</sub> = 18V		-1	-0.1		μA
	Crosstalk (control input to sign output)	$\begin{array}{c} V_C = 10V\\ \text{(square}\\ \text{wave), } t_r \text{, } t_f = \\ 20\text{ns, } R_L = \\ 10\text{k}\Omega  V_{DD} = \\ 10V \end{array}$	V <sub>DD</sub> = 10V			50		mV
		t <sub>r</sub> , t <sub>f</sub> = 20ns	V <sub>DD</sub> = 5V			35	70	ns
	Turn-on propagation delay	$C_L = 50pF$	V <sub>DD</sub> = 10V			20	40	ns
		$R_L = 1k\Omega$	V <sub>DD</sub> = 15V			15	30	ns
	Maximum control input repetit rate	$\begin{aligned} & V_{IN} = V_{DD}, \ C_L\\ &= 50 \text{pF}, \ R_L = \\ 1 \text{k}\Omega \\ & V_C = 10 \text{V}\\ \text{ion} & (\text{square wave centered on} \\ 5 \text{V}), \ t_r \ , \ t_f = \\ 20 \text{ns}, \ V_{os} = \\ 1 / 2 V_{os} \ \text{at} \\ 1 \text{kHz} \end{aligned}$	V <sub>DD</sub> = 10V			10		MHz
C <sub>IN</sub>	Input Capacitance					5	7.5	pF

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## 4.5 Electrical Characteristics (continued)

Over operating free-air temperature range,  $V_{SUPPLY} = \pm 5V$ , and  $R_L = 100\Omega$ , (unless otherwise noted)<sup>(1)</sup>

	PARAMETER		TEST CONDITIONS	MIN TYP MAX	UNIT	
			T <sub>A</sub> = -55°C	0.25		
			T <sub>A</sub> = -40°C	0.2		
		$V_{DD} = 5V$ $V_{is} = 0V$	T <sub>A</sub> = 25°C	0.2	mA	
		V IS	T <sub>A</sub> = 85°C	0.12		
			T <sub>A</sub> = 125°C	0.14		
			T <sub>A</sub> = -55°C	-0.25		
			T <sub>A</sub> = -40°C	-0.2		
		$V_{DD} = 5V$ $V_{is} = 5V$	T <sub>A</sub> = 25°C	-0.2	mA	
		VIS OV	T <sub>A</sub> = 85°C	-0.12		
			T <sub>A</sub> = 125°C	-0.14		
			T <sub>A</sub> = -55°C	0.62		
			T <sub>A</sub> = -40°C	0.5		
		$V_{DD} = 10V$ $V_{is} = 0V$	T <sub>A</sub> = 25°C	0.5	mA	
		V IS	T <sub>A</sub> = 85°C	0.3		
	Cwitch input current		T <sub>A</sub> = 125°C	0.35		
I <sub>IS</sub>	Switch input current		T <sub>A</sub> = -55°C	-0.62		
			T <sub>A</sub> = -40°C	-0.5		
		$V_{DD} = 10V$ $V_{is} = 10V$	T <sub>A</sub> = 25°C	-0.5	mA	
		V IS TO V	T <sub>A</sub> = 85°C	-0.3		
			T <sub>A</sub> = 125°C	-0.35		
			T <sub>A</sub> = -55°C	1.8		
			T <sub>A</sub> = -40°C	1.4		
		$V_{DD} = 15V$ $V_{is} = 0V$	T <sub>A</sub> = 25°C	1.5	mA	
		VIS OV	T <sub>A</sub> = 85°C	1		
			T <sub>A</sub> = 125°C	1.1		
			T <sub>A</sub> = -55°C	-1.8		
			T <sub>A</sub> = -40°C	-1.4		
		$V_{DD} = 15V$ $V_{is} = 15V$	T <sub>A</sub> = 25°C	-1.5	mA	
		T <sub>IS</sub>	T <sub>A</sub> = 85°C	-1		
			T <sub>A</sub> = 125°C	-1.1		
		$V_{DD} = 5V$ $V_{is} = 0V$		0.4	V	
		V <sub>DD</sub> = 5V V <sub>is</sub> = 5V		4.6	V	
\ <i>/</i>	Switch output valtees	V <sub>DD</sub> = 10V V <sub>is</sub> = 0V		0.5	V	
V <sub>OS</sub>	Switch output voltage	V <sub>DD</sub> = 10V V <sub>is</sub> = 10V		9.5	V	
		$V_{DD} = 15V$ $V_{is} = 0V$		1.5	٧	
		V <sub>DD</sub> = 15V V <sub>is</sub> = 15V		13.5	V	

<sup>(1)</sup> Peak-to-Peak voltage symmetrical about  $(V_{DD}-V_{EE})$  / 2.



## 4.6 Electrical Characteristics

		TEST CONDIT	TIONS		LIMIT	S AT INI	DICATE	TEMPE	ERATUR	ES (°C)	
CHARACTERISTIC		V <sub>IN</sub> (V) V <sub>DD</sub> (*							+	25	UNIT
			VIN (V)	▼DD (▼)	-55	-40	+85	+125	TYP	MAX	
			0,5	5	025	0.25	7.5	7.5	0.01	0.25	
Quiescent Device			0,10	10	0.5	0.5	15	15	0.01	0.5	μA
Current, I <sub>DD</sub>			0,15	15	1	1	30	30	0.01	1	μΑ.
			0,20	20	5	5	150	150	0.02	5	
Signal Inputs (V <sub>is</sub> ) and C	Output (V <sub>os</sub> )										
	$V_C = V_{DD}$ $V_{is} = V_{DD}$ or $V_{SS}$			10	600	610	840	960	-	660	
On-State	R <sub>L</sub> =10kΩ Returned to	V <sub>is</sub> =4.75 to 5.75V		10	1870	1900	2380	2600	-	2000	Ω
Resistance, r <sub>on</sub> MAX	V <sub>DD</sub> -V <sub>SS</sub>	V <sub>is</sub> =V <sub>DD</sub> or V <sub>SS</sub>		15	360	370	520	600	-	400	122
	2	V <sub>is</sub> =7.25 to 7.75V		15	775	790	1080	1230	-	850	
ΔOn-State				5	_	_	_	-	15	_	
Resistance Between	$R_L=10k\Omega$ , $V_C=V_{DD}$			10	_	_	_	-	10	_	Ω
Any 2 Switches, Δr <sub>on</sub>	tches, Δr <sub>on</sub>		15	_	_	_	_	5	_		
Total Harmonic			wave centered o								
Distortion, THD	$f_{is} = 1$ kHz sine wave			011 OV / TYL - TORS2,	_	-	-	-	0.4	-	%
-3dB Cutoff Frequency (Switch on)	<u> </u>			R <sub>L</sub> =1kΩ,	-	-	-	-	40	-	MHz
-50dB Feed-through Frequency (Switch off)	$V_C = V_{SS} = -5V$ , $V_{is(p-p)} = 5V$ (Sine wave centered on 0V) $R_L = 1$			1 lkΩ	-	-	-	-	1.25	-	MHz
Input/Output	V <sub>C</sub> = 0V										
Leakage Current	V <sub>is</sub> = 18V, V <sub>OS</sub> = 0V;			18	±0.1	±0.1	±1	±1	10-4	±0.1	μΑ
(Switch off) I <sub>is</sub> MAX	V <sub>is</sub> = 0V, V <sub>OS</sub> = 18V										
−50dB Crosstalk Frequency	$V_{C}(A) = V_{DD} = +5V$ , $V_{C}(B) = V_{SS} = -5V$ , $V_{is}(A) = 5V_{p-p}$ , $50\Omega$ source					_	_	_	0.9	_	MHz
	R <sub>L</sub> = 1kΩ										
Propagation	$R_L = 200k\Omega$			5	-	-	-	-	40	100	
Delay (Signal Input to	$V_C = V_{DD}, V_{SS} = GND, C_L = 50pF$			10	-	-	-	-	20	40	ns
Signal Output) t <sub>pd</sub>	$V_{is}$ = Square Wave 0 to $t_r$ , $t_f$ = 20ns	$V_{DD}$		15	_	_	-	-	15	30	
Capacitance:					_	_	-	-	4	_	
Input, C <sub>is</sub> Output, C <sub>OS</sub>	V <sub>DD</sub> = +5V				_	-	_	-	4	_	pF
Feed-through, C <sub>ios</sub>	V <sub>C</sub> =V <sub>SS</sub> =-5V				_	-	_	-	0.2	_	1
Control (V <sub>C</sub> )											
Control Input Low Voltage, V <sub>ILC</sub> (MAX)	$ I_{is}  < 10 \ \mu A$ $V_{is} = V_{SS}, V_{OS} = V_{DD}$ ar	and $V_{is} = V_{DD}$ , $V_{OS} =$	V <sub>SS</sub>	5,10, 15	0.9	0.9	0.4	0.4	_	0.7	V
	10 00 00 00	1.5 25 00		5					3	.5 (Min.)	
Control Input High	See Figure 4-5			10						7 (Min.)	4
Voltage, V <sub>IHC</sub>	Soo Figure 10			15						11 (Min.)	-
	Input Current, I <sub>IN</sub> (MAX)	V:-□ Vpp									
Input Current, I <sub>IN</sub>	V <sub>DD</sub> - V <sub>SS</sub> = 18V	VIS - VDD		18	±0.1	±0.1	±1	±1	±10 <sup>-5</sup>	±0.1	μA
(MAX)	V <sub>CC</sub> □ V <sub>DD</sub> - V <sub>SS</sub>										Par 1
	V <sub>C</sub> = 10V (Sq. Wave)										
Crosstalk (Control				10				_	50		mV
Input to Signal Output)	$t_r$ , $t_f = 20$ ns			- 10	Ι	_			30	<u> </u>	1110
	R <sub>L</sub> = 10kΩ	olayt t. = 20na		5	_	_	-	_	35	70	
Turn-On Propagation		1 0 , 1, 1				-	-	Ε	20	40	ns
urn-On Propagation Pelay	$C_L = 50pF$ $R_I = 1k\Omega$			10	<b>  -</b>						



## 4.6 Electrical Characteristics (continued)

	TEST CONDITIONS				LIMITS AT INDICATED TEMPERATURES (°C)					
CHARACTERISTIC		V 00	V <sub>DD</sub> (V)					+25		UNITS
		V <sub>IN</sub> (V)		-55	-40	+85	+125	TYP	MAX	
Repetition Rate	Maximum Control Input Repetition Rate $V_{is} = V_{DD} < V_{SS} = GND, R_L = 1k\Omega$ to GND, $C_L = 50pF, V_C = 10V(Square wave centered on 5V)$ $t_r, t_f = 20ns, V_{OS} = \frac{1}{2}V_{OS}$ at 1kHz		10	-	-	_	-	10	-	MHz
Input Capacitance, C <sub>IN</sub>				-	-	_	_	5	7.5	μF

## 4.7 Typical Characteristics

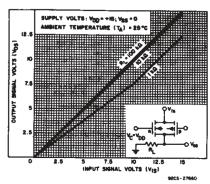


Figure 4-1. On-state Characteristics for 1 of 4 Switches with  $v_{DD}$  = +15V,  $v_{SS}$  = 0V.

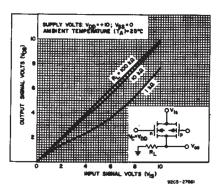


Figure 4-2. On-state Characteristics for 1 of 4 Switches with  $v_{DD}$  =+10V,  $v_{SS}$  = 0V.

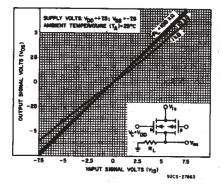


Figure 4-3. On-state Characteristics for 1 of 4 Switches with  $v_{DD}$  = +7.5V,  $v_{SS}$ = - 7.5V.

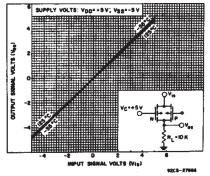


Figure 4-4. On-state Characteristics as a Function of Temp. for 1 of 4 Switches with  $v_{DD}$  = +5V,  $v_{SS}$  = - 5V.

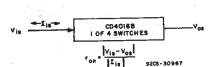


Figure 4-5. Determination of  $R_{\text{on}}$  As a Test Condition for Control Input High Voltage Specification.



## **5 Parameter Measurement Information**

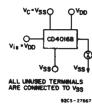


Figure 5-1. Off-state Switch Input or Output Leakage Current Test Circuit.

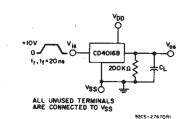


Figure 5-3. Propagation Delay Time Signal Input (v<sub>IS</sub>) To Signal Output (v<sub>OS</sub>)

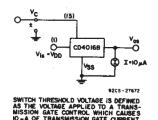


Figure 5-5. Switch Threshold Voltage.

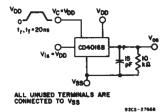


Figure 5-2. Test Circuit for Square-wave Response.

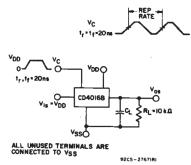


Figure 5-4. MAX Control-input Repetition Rate.

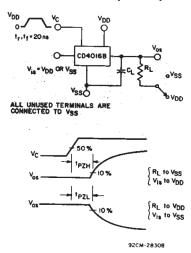


Figure 5-6. Turn-On Propagation Delay-control Input.



## 6 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

## **6.1 Documentation Support**

#### 6.1.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on Notifications to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 6.1.2 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 6.1.3 Trademarks

TI E2E™ is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

#### 6.1.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 6.1.5 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

#### 7 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

C	hanges from Revision C (September 2003) to Revision D (May 2024)	Page
•	Increased IDD max/typ for the lower Temperature cases	5
•	Changed typical IIH to 0.5µA	5
	Changed typical IIL to -0.1µA	
	5 71	

## 8 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

www.ti.com 1-May-2024

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9064001CA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9064001CA CD4016BF3A	Samples
CD4016BE	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD4016BE	Samples
CD4016BEE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD4016BE	Samples
CD4016BF	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD4016BF	Samples
CD4016BF3A	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9064001CA CD4016BF3A	Samples
CD4016BM	LIFEBUY	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4016BM	
CD4016BM96	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4016BM	Samples
CD4016BMG4	LIFEBUY	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4016BM	
CD4016BMT	LIFEBUY	SOIC	D	14	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4016BM	
CD4016BNSR	NRND	so	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4016B	
CD4016BPW	NRND	TSSOP	PW	14	90	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM016B	
CD4016BPWR	NRND	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM016B	

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

## PACKAGE OPTION ADDENDUM

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(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF CD4016B, CD4016B-MIL:

Catalog: CD4016B

Military: CD4016B-MIL

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

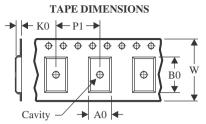
• Military - QML certified for Military and Defense Applications

# **PACKAGE MATERIALS INFORMATION**

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## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD4016BM96	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
CD4016BMT	SOIC	D	14	250	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
CD4016BNSR	so	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
CD4016BPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



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## \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD4016BM96	SOIC	D	14	2500	356.0	356.0	35.0
CD4016BMT	SOIC	D	14	250	210.0	185.0	35.0
CD4016BNSR	SO	NS	14	2000	356.0	356.0	35.0
CD4016BPWR	TSSOP	PW	14	2000	367.0	367.0	35.0

# **PACKAGE MATERIALS INFORMATION**

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## **TUBE**



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
CD4016BE	N	PDIP	14	25	506	13.97	11230	4.32
CD4016BE	N	PDIP	14	25	506	13.97	11230	4.32
CD4016BEE4	N	PDIP	14	25	506	13.97	11230	4.32
CD4016BEE4	N	PDIP	14	25	506	13.97	11230	4.32
CD4016BM	D	SOIC	14	50	506.6	8	3940	4.32
CD4016BMG4	D	SOIC	14	50	506.6	8	3940	4.32
CD4016BPW	PW	TSSOP	14	90	530	10.2	3600	3.5

## **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
   Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
   Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



# D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
  - Sody length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



# PW (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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